

Appendix A. Identification of Amended Material

1. (AMENDED) An electronic package comprising:

a metal member;

a dielectric layer positioned on said metal member, [;] wherein

said dielectric layer comprises a photo-imageable dielectric material;

an active element positioned on said dielectric layer;

a first plurality of electrically conductive members positioned on said dielectric layer relative to said active element;

a plurality of metallic traces on said dielectric layer, selected ones of said metallic traces in electrical contact with said active element and selected ones of said first plurality of electrically conductive members;

a second plurality of electrically conductive members positioned on said dielectric layer; and

at least one electrically conductive via in said dielectric layer, said at least one of said second plurality of electrically conductive members in contact with said metal member not electrically coupled to said metallic traces.